

RH1042Q Product Datasheet

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Revision History

| Rev | Date | Description |
|------------|-------------|----------------------|
| A | 10/23/2024 | Initial introduction |

1 General Description

The RH1042Q is a new generation of high-speed 8Mbps Controller Area Network (CAN) transceiver that is in compliance with ISO 11898-2:2016 and SAE J2284-1 to SAE J3384-5 high-speed CAN specifications. This transceiver provides an interface between a CAN protocol controller and the physical two-wire CAN bus for CAN applications in the automotive and industrial markets.

The RH1042Q features two modes of operation: Normal and Standby mode, which are selected through STB pin. Normal mode allows data rate exceeding 8Mbps, and Standby mode disables the transmitter, and puts the transceiver in low-current mode, with its RXD output reflects the status when bus dominant and recessive states persist longer than the wake-up filter timing. In Normal mode, the receiver input has an extended input common-mode range from -40V to +40V, exceeding the ISO 11898 specification of -2V to +7V. The transceiver also features integrated level shifters referenced to the V_{IO} pin, which allows transceiver to interface directly with controller having 2.8V~5.5V logic level.

This transceiver integrates many protections such as thermal shutdown, current-limiting, TXD-dominant timeout, bus fault protection up to $\pm 70V$, and fail-safe when supply is under-voltage or floating. It also provides robust $\pm 25kV$ HBM, $\pm 15kV$ IEC Air Gap and $\pm 8kV$ IEC Contact protection on bus pins.

The RH1042Q is available in 8-pin SO package and operates over $-40^{\circ}C$ to $+125^{\circ}C$ extended temperature range.

2 Features

- ISO 11898-2:2016 and SAE J2284-1 to ADE J2284-5 compliant
- Support classical CAN and optimized CAN FD at 500kbps, 1Mbps, 5Mbps, and 8Mbps
- Support 12V, 24V and 48V systems
- Low electromagnetic emission, and high electromagnetic immunity
- $\pm 25kV$ HBM ESD tolerance on CAN bus, $\pm 6kV$ HBM ESD tolerance on all other pins
- $\pm 15kV$ IEC Air Gap Discharge and $\pm 8kV$ IEC Contact Discharge on CAN bus
- All pins pass $\pm 1.5kV$ CDM, and $\pm 400mA$ Latch-up test
- Bus fault voltage protection to $\pm 70V$
- Bulk Current Injection (BCI) passes ISO 11452-4:2011 400mA
- Perfect signal symmetry greatly improves EMI
- Transmitter TXD-dominant time-out
- Receiver extended common-mode input voltage range from -40V to +40V
- Support controller I/O's logical voltage level from 2.8V to 5.5V with separate V_{IO} pin
- Two operating modes: Normal mode and Standby mode
- Protection features: thermal-shutdown, under-voltage lockout, short-circuit current limit
- Available in industry-standard 8-pin SOIC package
- AEC-Q100 qualified

3 Applications

- Automotive Body Control Module, Gateway, Driver Assistance System, Infotainment
- Hybrid, Electric and Powertrain Systems
- Power System Communications
- Industrial Control and Networks
- Telecommunication Backplane
- Energy Storage Systems
- Building Automation

4 Typical Operating Circuit

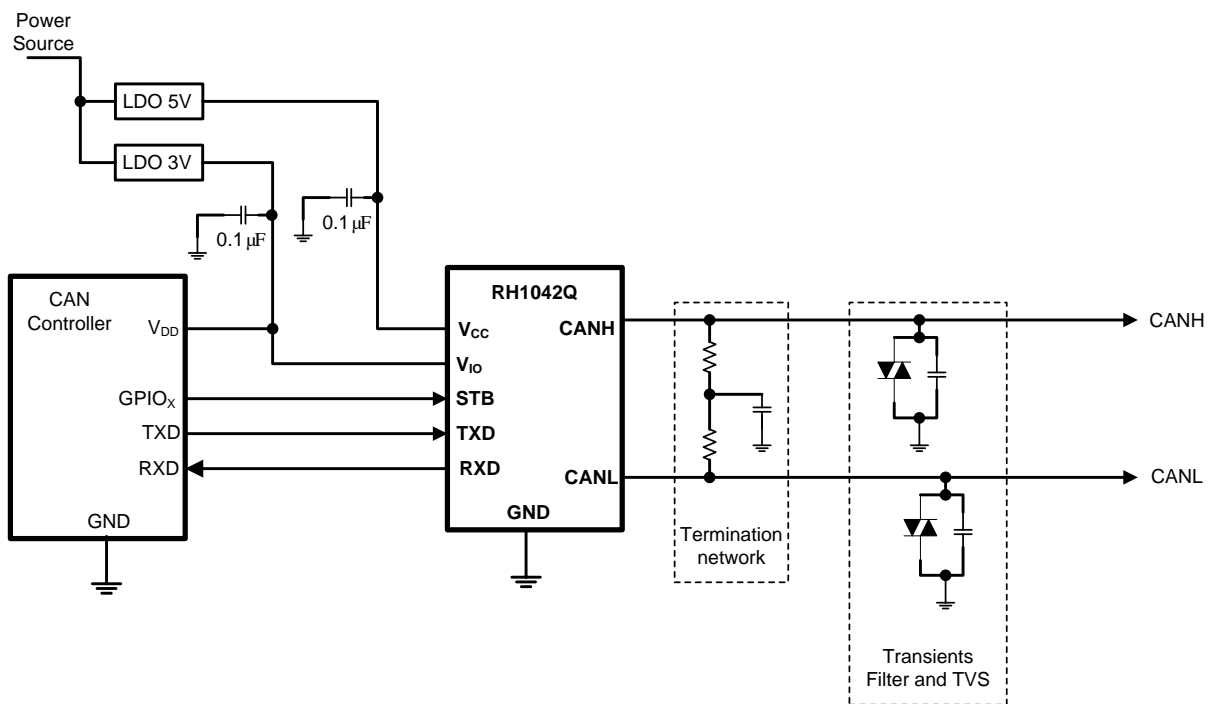


Figure 1 – Typical Operating Circuit

5 Ordering Information

| Part Number | Temperature Range | Package-Pin | Description |
|--------------|-------------------|-------------|--|
| RH1042ASCQ+ | -40°C to +125°C | SO-8 | SO-8, body width 3.9mm in tube, Auto Grade1 |
| RH1042ASCQ+T | -40°C to +125°C | SO-8 | SO-8, body width 3.9mm in tape and reel, Auto Grade1 |

Table 1 – Ordering Information

6 Pin Configuration and Functions

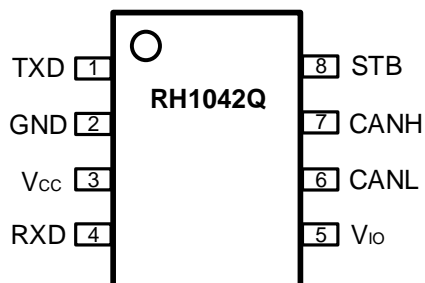


Figure 2 – Device in SO-8 Package

| Pin Number | Pin Name | Pin Type | Description |
|------------|-----------------|----------------|---|
| 1 | TXD | Digital Input | Transmit Data Input, with an internal pull-up. |
| 2 | GND | Ground | Ground. |
| 3 | V _{CC} | Power | 5V Power Supply. |
| 4 | RXD | Digital Output | Receiver Data Output. |
| 5 | V _{IO} | Power | 2.8V to 5.5V Power Supply for digital input/output. |
| 6 | CANL | Analog Bus I/O | CAN Low Bus input/output. |
| 7 | CANH | Analog Bus I/O | CAN High Bus input/output. |
| 8 | STB | Digital Input | Standby mode control, with an internal pull-up. |

Table 2 – Pin Functions

7 Functional Description

The RH1042Q is a high-speed 8Mbps CAN-FD transceiver with pin-selectable Normal mode and Standby mode. It has enhanced EMC and ESD protection for both digital and bus pins, bus fault voltage protection up to $\pm 70V$, and an extended receiver input common-mode voltage range to $\pm 40V$ that provides ample application flexibility.

7.1 Operating modes

The RH1042Q supports two operating modes: Normal mode and Standby mode, which can be pin-selectable through STB pin.

| Operating Mode | Input Pin | | Output | | |
|----------------|-----------|------|---------------|--|------|
| | STB | TXD | Driver status | Receiver status | RXD |
| Normal | Low | Low | dominant | high power receiver active | Low |
| | Low | High | recessive | high power receiver active | High |
| Standby | High | Low | disabled | low power receiver active wake-up request detected | Low |
| | High | High | disabled | low power receiver active No wake-up request detected | High |

Table 3 – Device Operating Modes

7.1.1 Normal mode

Connect STB to logic Low sets RH1042Q to Normal mode. In this mode, the driver transmits data thru TXD and outputs CAN-compliant signals at bus CANH and CANL. When TXD is at logic Low, CAN bus is in dominant state; when TXD is at logic High, CAN bus is in recessive state. The differential receiver converts CAN bus signals into digital output RXD: logic Low (dominant state) when $V_{CANH} > V_{CANL}$, logic High (recessive state) when $V_{CANH} \leq V_{CANL}$. This transceiver can achieve data transmission rate exceeding 8Mbps.

7.1.2 Standby mode

Connect STB to logic High sets RH1042Q to Standby mode. In this mode, the driver is disabled and its outputs are released. A low-power differential receiver is enabled to monitor the bus lines for activity. A wake-up monitoring filter is also active in Standby mode.

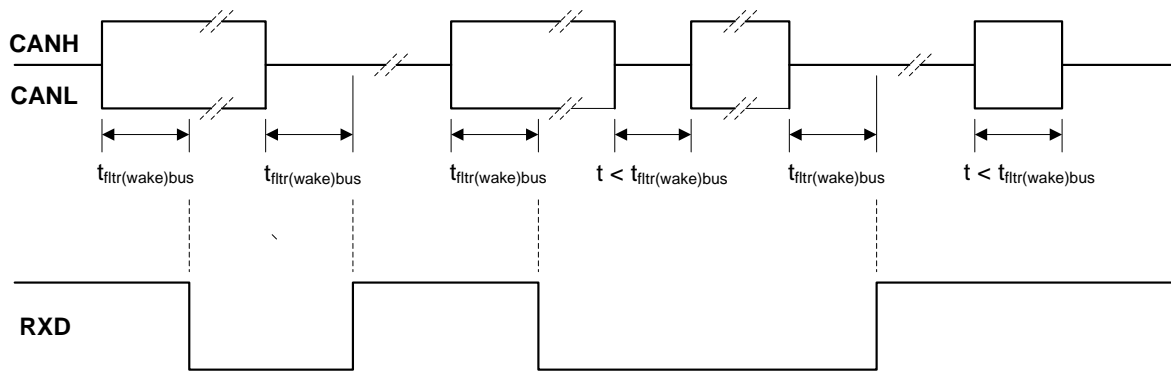


Figure 3 – Standby mode Wake-up Timing

The wake-up filter at the low-power receiver does not latch bus dominant states, but reflects the bus wake-up status at RXD pin when bus dominant and bus recessive states are present and persist longer than $t_{\text{filt(wake)bus}}$ timing. RXD pin outputs a logic low when a wake-up request is detected, and outputs a logic high when no wake-up request is detected. The low-power receiver is supplied by V_{IO} , and is capable of detecting CAN bus activity even if V_{IO} is the only supply voltage available.

7.2 Driver and Receiver Function

The digital logic inputs (TXD, STB) and output (RXD) are CMOS/TTL levels with respect to V_{IO} . The V_{IO} ranges from 2.8V~5.5V, which can align with controllers having 3.3V or 5V I/O's.

| Device Mode | Digital Input | | Driver Status | Bus Outputs | | Bus state |
|-------------|---------------|---------------|---------------|----------------|----------------|--|
| | STB | TXD | | CANH | CANL | |
| Normal | Low | Low | enabled | High | Low | dominant |
| | Low | High | enabled | High impedance | High impedance | recessive, bus biased to $\sim V_{CC}/2$ |
| Standby | High | X, don't care | disabled | High impedance | High impedance | released |

Table 4 – Driver Functions

| Device Mode | Digital Input | Receiver Status | | CAN Differential Inputs | Digital Output | Bus State |
|-------------|---------------|-----------------|------------------|--|----------------|-----------------------------|
| | STB | Normal Receiver | Wake-up Receiver | $V_{ID} = V_{CANH} - V_{CANL}$ | RXD | |
| Normal | Low | enabled | disabled | $V_{ID} \geq 0.9V$ | Low | dominant |
| | Low | enabled | disabled | $0.5V < V_{ID} < 0.9V$ | undefined | undefined |
| | Low | enabled | disabled | $V_{ID} \leq 0.5V$ | High | recessive |
| Standby | High | disabled | enabled | $V_{ID} \geq 1.15V$ or $V_{ID} \leq 0.4V$, AND dominant/recessive time $> t_{\text{filt(wake)bus}}$ | Low | wake-up request detected |
| | High | disabled | enabled | $0.4V < V_{ID} < 1.15V$, or $V_{ID} \geq 1.15V$, or $V_{ID} \leq 0.4V$, AND time $< t_{\text{filt(wake)bus}}$ | High | No wake-up request detected |

Table 5 – Receiver Functions

7.3 Integrated Protection

7.3.1 Bus Fault Protection

The RH1042Q features $\pm 70\text{V}$ of fault protection. CANH or CANL can tolerate an external short fault from -70V to $+70\text{V}$ without any damage to the device. Data transmission resumes once the fault voltage is no longer present. In addition to bus fault protection, the RH1042Q disengages from the bus when it is not powered up (V_{CC} left floating), and releases itself from the bus.

7.3.2 Driver Output Protection

The RH1042Q protects the driver output stage against short-circuit to a positive or negative voltage by limiting the output source or sink current. On-chip thermal shutdown circuit further protects the device and disables the driver if the junction temperature of the RH1042Q exceeds the thermal shutdown threshold. The driver returns to normal operation once the junction temperature drops below the thermal shutdown threshold voltage with hysteresis.

7.3.3 Driver TXD Dominant Timeout

The RH1042Q features a driver dominant timeout that prevents CAN controller from dominating the bus more than $t_{to(dom)TXD}$, or limits the minimum possible data rate to $\sim 20\text{kbps}$. In dominant timeout, the driver is disabled and releases the bus to recessive state. The driver is enabled and enters into dominant state when TXD transits from High to Low.

7.3.4 Bus Dominant Timeout in Standby mode

In Standby mode, the RH1042Q features a bus dominant timeout that prevents CAN controller from dominating the bus when bus changes from recessive to dominant state and its dominant state persists more than $t_{to(dom)bus}$. In this timeout state, RXD pin is reset to logic high. This function prevents a clamped dominant bus from generating a permanent wake-up request. The bus dominant timeout is reset when the CAN bus changes from dominant to recessive state.

7.3.5 Internal Biasing of TXD and STB Input Pins

Input pin TXD has an internal pull-up to V_{IO} , such that when it is left floating, the driver stays in recessive and releases the bus. Input pin STB has an internal pull-up to V_{IO} , such that when it is left floating, the device is in Standby mode. To minimize standby current, both pins should be held to V_{IO} in Standby mode.

7.3.6 Undervoltage Detection on Power V_{CC} and V_{IO} Pins

The RH1042Q incorporates separate undervoltage detection for both V_{CC} and V_{IO} pins. The 5V V_{CC} pin supplies power to the device, and if it drops below V_{CC} 's undervoltage threshold, both the driver and receiver will be disabled and the device enters into Standby mode, until V_{CC} has recovered, regardless to the logic state of STB pin.

The V_{IO} pin supplies power to both the digital inputs (TXD and STB) and output pin (RXD), allowing the RH1042Q to interface with controller having GPIO's from 2.8V to 5.5V. If V_{IO} drops below V_{IO} 's undervoltage threshold, the driver will be disabled and it disengages from the bus, until V_{IO} has recovered.

7.3.7 Extended Receiver Input Common-mode Range

The RH1042Q features a strong differential receiver that has an extended input common-mode range from -40V to +40V, exceeding the ISO 11898 specification of -2V to +7V. It allows error-free data transmission exceeding 8Mbps through the whole common-mode range. In Standby mode, a low-power differential receiver is enabled, which also has an extended input common-mode range from -12V to +12V to detect for wake-up request.

7.3.8 EMC/ESD Protection

The RH1042Q incorporates high $\pm 25\text{kV}$ ESD Human Body Model (HBM) protection at both of the CANH and CANL pins. For all other pins, $\pm 6\text{kV}$ HBM ESD can be tolerated without any damage. In addition, both CANH and CANL pins pass $\pm 15\text{kV}$ IEC Air Gap and $\pm 8\text{kV}$ IEC Contact Discharge. Furthermore, all pins can tolerate at least $\pm 1.5\text{kV}$ per Charged-device Model (CDM), and pass $\pm 400\text{mA}$ Latch-up (LU) test. For Bulk Current Injection (BCI), RH1042Q passes the ISO 11452-4:2011 400mA.

8 Specifications

8.1 Absolute Maximum Ratings

| Absolute Maximum Ratings | | | | | | |
|----------------------------|--------------------------------------|--|------|------|-----|------|
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| ESD/Voltage ratings | | | | | | |
| V _{ESD} | electrostatic discharge voltage | IEC61000-4-2 Air Gap at CANH, CANL | | ±15 | | kV |
| | | IEC61000-4-2 Contact Discharge at CANH, CANL | | ±8 | | kV |
| | | HBM at CANH, CANL | | ±25 | | kV |
| | | HBM at other pins | | ±6 | | kV |
| | | CDM field induced charge at all pins | | ±1.5 | | kV |
| LU | latch-up | Latch-up test at all pins | | ±400 | | mA |
| V _{CANH} | voltage on pin CANH | | -70 | | +70 | V |
| V _{CANL} | voltage on pin CANL | | -70 | | +70 | V |
| V _X | voltage on pins other than CANH/CANL | | -0.3 | | +6 | V |
| V _(CANH-CANL) | voltage between CANH and CANL | | -34 | | +34 | V |
| Temperature | | | | | | |
| T _J | junction temperature | | | | 150 | °C |
| T _S | storage temperature | | -55 | | 150 | °C |
| T _{SD} | Thermal shutdown temperature | | | 160 | | °C |
| | Thermal shutdown hysteresis | | | 15 | | °C |

8.2 Electrical Characteristics

| Static Characteristics | | | | | | |
|--|---|--|---------------------|-----|----------------------|------|
| T _J =-40°C to +125°C; V _{CC} =4.5V to 5.5V; V _{IO} =2.8V to 5.5V; R _I =60Ω unless specified otherwise. | | | | | | |
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| Supply - pin V_{CC} | | | | | | |
| V _{CC} | supply voltage | | 4.5 | | 5.5 | V |
| I _{CC} | supply current | Standby mode | | 1.8 | 5 | μA |
| | | Normal mode | | | | |
| | | recessive, V _{TXD} =V _{IO} | | 2.2 | 5 | mA |
| | | dominant, V _{TXD} =0V | | 40 | 60 | mA |
| | | dominant, V _{TXD} =0V; short circuit on bus lines; -3V < (V _{CANH} =V _{CANL}) < +18V | | 80 | 110 | mA |
| V _{UVLO(VCC)} | undervoltage detection voltage on pin V _{CC} | | 3 | 3.5 | 4.2 | V |
| I/O level adapter Supply - pin V_{IO} | | | | | | |
| V _{IO} | supply voltage on V _{IO} | | 2.8 | | 5.5 | V |
| I _{VIO} | supply current on V _{IO} | Standby mode | | | | |
| | | V _{TXD} =V _{IO} | | 7 | 14 | μA |
| | | Normal mode | | | | |
| | | recessive, V _{TXD} =V _{IO} | | 30 | 100 | μA |
| | | dominant, V _{TXD} =0V | | 200 | 800 | μA |
| V _{UVLO(VIO)} | undervoltage detection voltage on V _{IO} | | 1.3 | 1.8 | 2.5 | V |
| Mode control inputs - pin STB | | | | | | |
| V _{IH} | input high voltage | | 0.7*V _{IO} | | V _{IO} +0.3 | V |
| V _{IL} | input low voltage | | -0.3 | | 0.3*V _{IO} | V |
| I _{IH} | input high current | V _{STB} =V _{IO} | -1 | | 1 | μA |
| I _{IL} | input low current | V _{STB} =0V | | 30 | 50 | μA |

| Static Characteristics (Continue) | | | | | | | |
|--|--|--|---------------------|---------------------|----------------------|------|--|
| T _J = -40°C to +125°C; V _{CC} = 4.5V to 5.5V; V _{IO} = 2.8V to 5.5V; R _L = 60Ω unless specified otherwise. | | | | | | | |
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
| CAN transmit data input - pin TXD | | | | | | | |
| V _{IH} | input high voltage | | 0.7*V _{IO} | | V _{IO} +0.3 | V | |
| V _{IL} | input low voltage | | -0.3 | | 0.3*V _{IO} | V | |
| I _{IH} | input high current | V _{TXD} =V _{IO} | -1 | | 1 | μA | |
| I _{IL} | input low current | V _{TXD} =0V | | 30 | 50 | μA | |
| C _{in} | input capacitance | | | 5 | | pF | |
| CAN receive data output - pin RXD | | | | | | | |
| I _{OH} | output high current | V _{RXD} =V _{IO} -0.4V | 8 | 20 | | mA | |
| I _{OL} | output low current | V _{RXD} =0.4V, bus dominant | 8 | 30 | | mA | |
| Bus lines - pins CANH and CANL | | | | | | | |
| V _{O(dom)} | dominant output voltage | V _{TXD} =0V, t < t _{to(dom)TXD} ; Figure 6 | | | | | |
| | | CANH - R _L =50Ω to 65Ω | 2.75 | 3.5 | 4.5 | V | |
| | | CANL - R _L =50Ω to 65Ω | 0.5 | 1.5 | 2.25 | V | |
| V _{dom(TX)symm} | transmitter dominant voltage symmetry | V _{dom(TX)symm} =V _{CC} -V _{CANH} -V _{CANL} ; Figure 6 | -400 | | 400 | mV | |
| V _{TXsymm} | transmitter voltage symmetry | V _{TXsymm} =V _{CANH} +V _{CANL} ; f _{TXD} =250kHz, 1MHz, and 2.5MHz; V _{CC} =4.75V to 5.25V; C _{SPLIT} =4.7nF; Figure 7 | 0.9*V _{CC} | | 1.1*V _{CC} | V | |
| V _{O(diff)} | differential output voltage | dominant Normal mode: V _{TXD} =0V, t<t _{to(dom)TXD} ; Figure 6 | | | | | |
| | | R _L =45Ω to 65Ω | 1.5 | | 3 | V | |
| | | R _L =45Ω to 70Ω | 1.5 | | 3.3 | V | |
| | | R _L =2240Ω | 1.5 | | 5 | V | |
| | | recessive mode: no load; Figure 6 | | | | | |
| | | Normal mode: V _{TXD} =V _{IO} | -50 | | 50 | mV | |
| V _{O(rec)} | recessive output voltage | Standby mode: no load; Figure 6 | -0.1 | | 0.1 | V | |
| | | Normal mode: V _{TXD} =V _{IO} , no load; Figure 6 | 2 | 0.5*V _{CC} | 3 | V | |
| V _{th(RX)diff} | differential receiver threshold voltage | Normal mode: -40V≤V _{CANH} ≤+40V, -40V≤V _{CANL} ≤+40V | 0.5 | 0.7 | 0.9 | V | |
| | | Standby mode: -12V≤V _{CANH} ≤+12V, -12V≤V _{CANL} ≤+12V | 0.4 | 0.7 | 1.15 | V | |
| V _{rec(RX)} | receiver recessive voltage | Normal mode: -40V≤V _{CANH} ≤+40V, -40V≤V _{CANL} ≤+40V | -4 | | 0.5 | V | |
| | | Standby mode: -12V≤V _{CANH} ≤+12V, -12V≤V _{CANL} ≤+12V | -4 | | 0.4 | V | |
| V _{dom(RX)} | receiver dominant voltage | Normal mode: -40V≤V _{CANH} ≤+40V, -40V≤V _{CANL} ≤+40V | 0.9 | | 9 | V | |
| | | Standby mode: -12V≤V _{CANH} ≤+12V, -12V≤V _{CANL} ≤+12V | 1.15 | | 9 | V | |
| V _{hys(RX)diff} | differential receiver hysteresis voltage | Normal mode: -40V≤V _{CANH} ≤+40V, -40V≤V _{CANL} ≤+40V | | 100 | | mV | |
| | | Standby mode: -12V≤V _{CANH} ≤+12V, -12V≤V _{CANL} ≤+12V | | 50 | | mV | |
| I _{O(sc)dom} | dominant short-circuit output current | V _{TXD} =0V, t<t _{to(dom)TXD} , V _{CC} =5V | | | | | |
| | | V _{CANH} = -15V to +40V | -100 | | | mA | |
| | | V _{CANL} = -15V to +40V | | | 100 | mA | |
| I _{O(sc)rec} | recessive short-circuit output current | V _{TXD} =V _{IO} , V _{CANH} =V _{CANL} =±40V | | 2 | 5 | mA | |
| I _L | output leakage current | V _{CC} =V _{IO} = 0V; V _{CANH} =V _{CANL} =5V | | 2.5 | 5 | μA | |
| | | V _{CC} =V _{IO} =shorted to GND via 47kΩ; V _{CANH} =V _{CANL} =5V | | 2.5 | 5 | μA | |
| R _{in} | input resistance | -2V≤V _{CANL} ≤+7V, -2V≤V _{CANH} ≤+7V | 18 | 30 | 52 | kΩ | |
| ΔR _{in} | input resistance deviation | 0V≤V _{CANL} ≤+5V, 0V≤V _{CANH} ≤+5V | -1 | | 1 | % | |
| R _{in(diff)} | differential input resistance | -2V≤V _{CANL} ≤+7V, -2V≤V _{CANH} ≤+7V | 36 | 60 | 104 | kΩ | |
| C _{in(cm)} | common-mode input capacitance | | | 15 | | pF | |
| C _{in(diff)} | differential input capacitance | | | 8 | | pF | |

| Dynamic Characteristics | | | | | | |
|--|--------------------------------------|---|-----|-----|-----|------|
| T _j =-40°C to +125°C; V _{CC} =4.5V to 5.5V; V _{IO} =2.8V to 5.5V; R _L =60Ω unless specified otherwise. | | | | | | |
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| Transceiver timing: CANH, CANL, TXD and RXD | | | | | | |
| t _{d(TXD-busdom)} | delay time from TXD to bus dominant | Normal mode, Figure 4 | | 15 | 40 | ns |
| t _{d(TXD-busrec)} | delay time from TXD to bus recessive | Normal mode, Figure 4 | | 35 | 60 | ns |
| t _{d(busdom-RXD)} | delay time from bus dominant to RXD | Normal mode, Figure 4 | | 115 | 150 | ns |
| t _{d(busrec-RXD)} | delay time from bus recessive to RXD | Normal mode, Figure 4 | | 110 | 150 | ns |
| t _{d(TXDL-RXDL)} | delay time from TXD LOW to RXD LOW | Normal mode, Figure 4 | | 125 | 190 | ns |
| t _{d(TXDH-RXDH)} | delay time from TXD HIGH to RXD HIGH | Normal mode, Figure 4 | | 140 | 190 | ns |
| t _{bit(bus)} | transmitted recessive bit width | t _{bit(TXD)} =500ns, 2Mbps, Figure 5 | 435 | | 530 | ns |
| | | t _{bit(TXD)} =200ns, 5Mbps, Figure 5 | 155 | | 210 | ns |
| | | t _{bit(TXD)} =125ns, 8Mbps, Figure 5 | 100 | | 140 | ns |
| t _{bit(RXD)} | bit time on RXD | t _{bit(TXD)} =500ns, 2Mbps, Figure 5 | 400 | | 550 | ns |
| | | t _{bit(TXD)} =200ns, 5Mbps, Figure 5 | 120 | | 220 | ns |
| | | t _{bit(TXD)} =125ns, 8Mbps, Figure 5 | 85 | | 135 | ns |
| Δt _{symm(rec)} | receiver timing symmetry | t _{bit(TXD)} =500ns, 2Mbps, Figure 5 | -65 | | 40 | ns |
| | | t _{bit(TXD)} =200ns, 5Mbps, Figure 5 | -45 | | 15 | ns |
| | | t _{bit(TXD)} =125ns, 8Mbps, Figure 5 | -45 | | 10 | ns |
| t _{to(dom)TXD} | TXD dominant time-out time | V _{TXD} =0V, Normal mode | 0.3 | 3 | 5 | ms |
| t _{to(dom)bus} | bus dominant time-out time | Standby mode | 0.3 | 1.5 | 5 | ms |
| t _{fltr(wake)bus} | bus wake-up filter time | Standby mode | 0.2 | 0.5 | 5 | μs |
| t _{d(stb-norm)} | Standby to Normal mode delay time | | 6 | 10 | 45 | μs |

8.3 Timing Diagrams

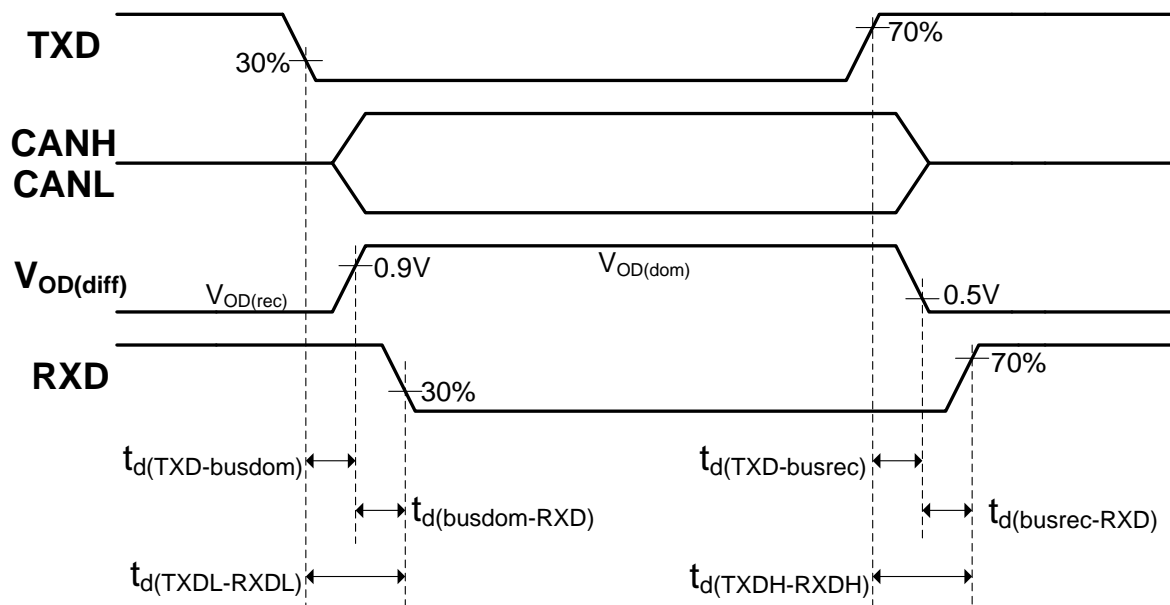


Figure 4 – CAN Transceiver Timing Diagram

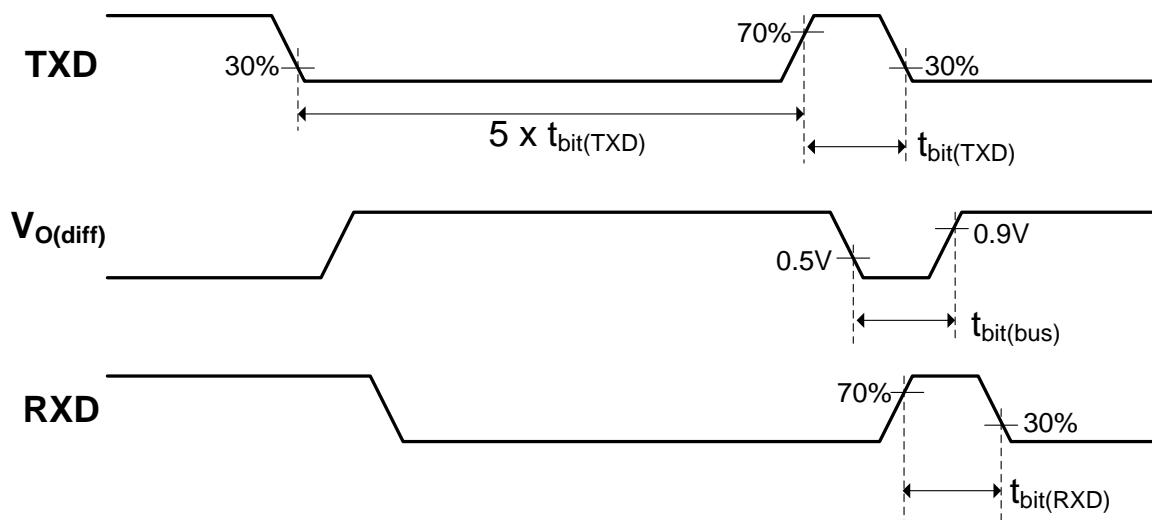


Figure 5 – CAN FD Bitwidth Timing Diagram

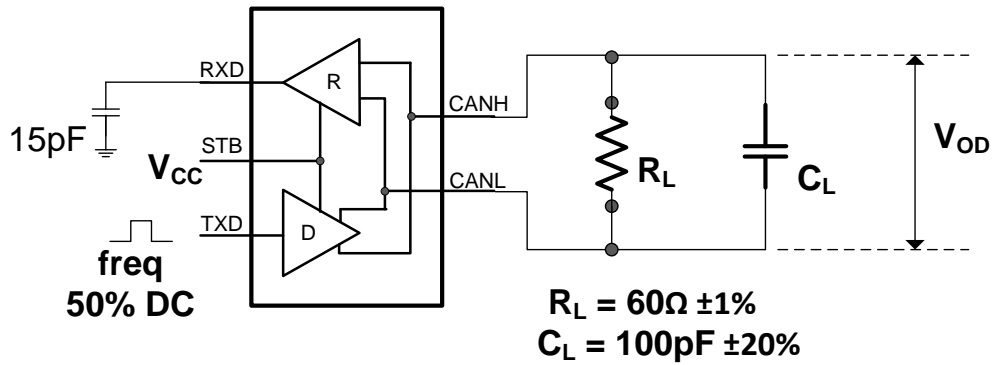


Figure 6 – CAN Transceiver Timing Test Setup Circuit

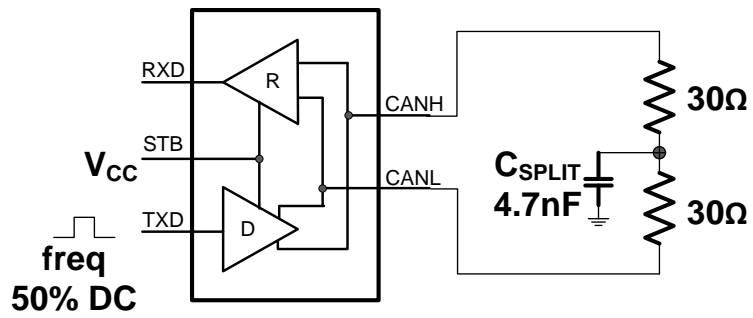
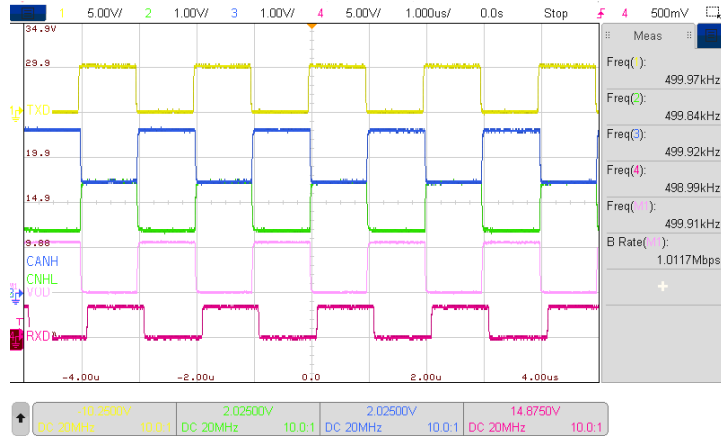


Figure 7 – CAN Transceiver Driver Symmetry Test Setup Circuit

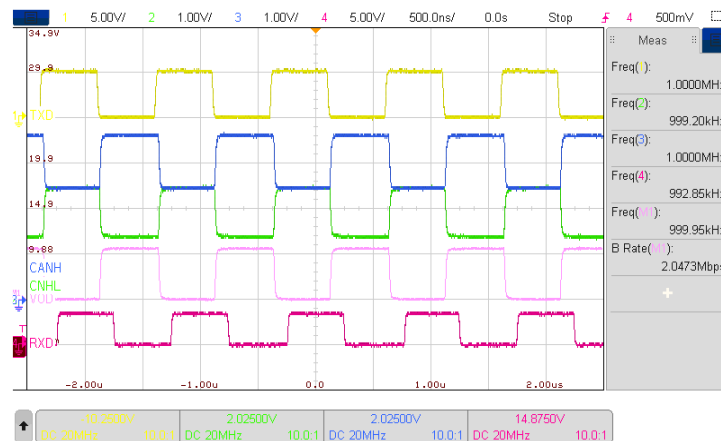
9 Typical Operating Characteristics

$V_{CC}=5.0V$, $V_{IO}=5.0V$, $R_L=30\Omega+30\Omega$, $C_{SPLIT}=4.7nF$, $T_A=25^\circ C$, unless specified otherwise.

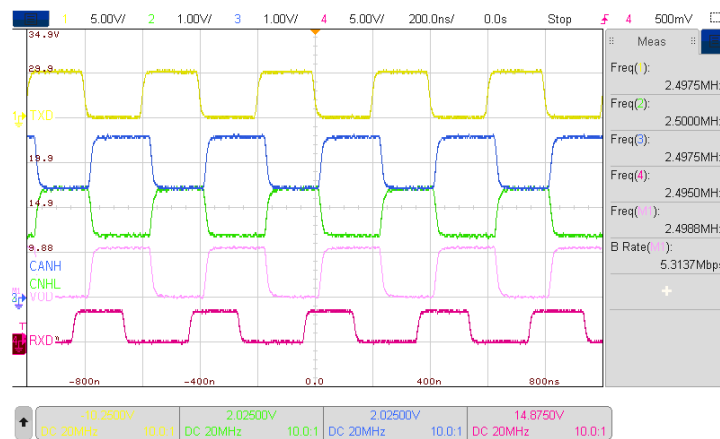
9.1 TXD/CANH/CANL/RXD waveform in different frequencies



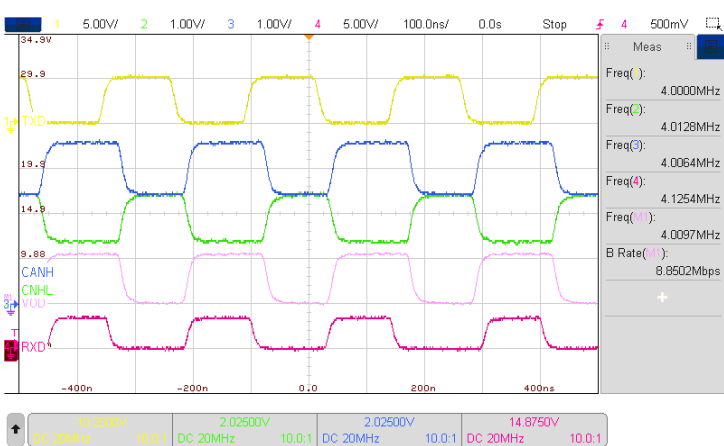
Data Rate = 1Mbps



Data Rate = 2Mbps

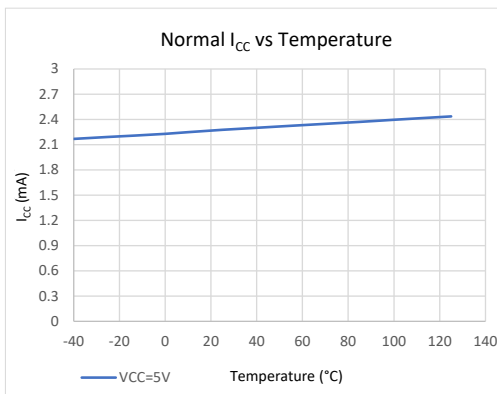
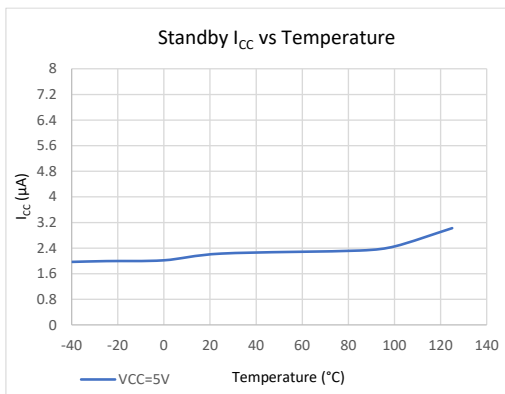


Data Rate = 5Mbps

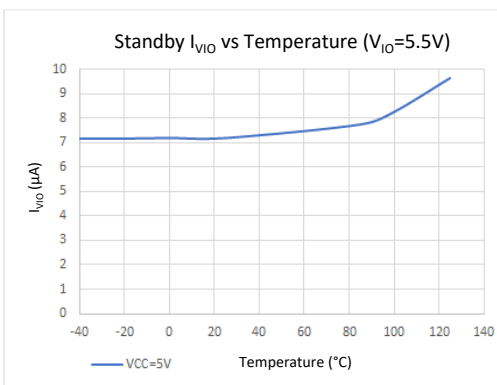
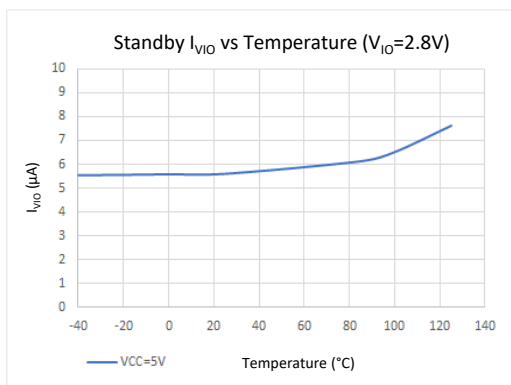


Data Rate = 8Mbps

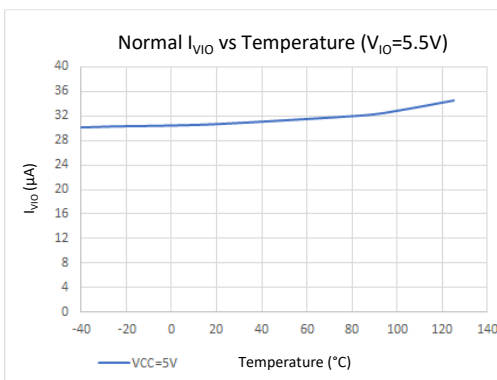
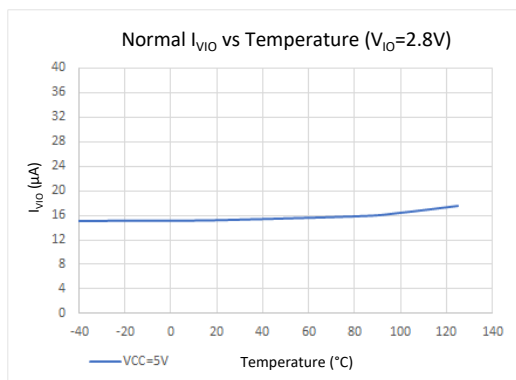
9.2 I_{CC} & I_{VIO} vs Temperature



Standby & Normal Quiescent I_{CC} vs Temperature (V_{IO}=2.8V or V_{IO}=5.5V)

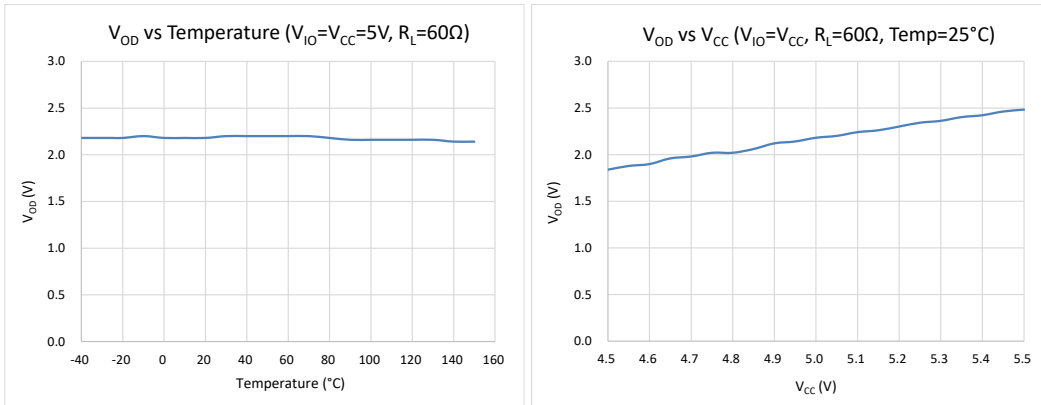


Standby Mode I_{VIO} vs Temperature (V_{CC}=5V)

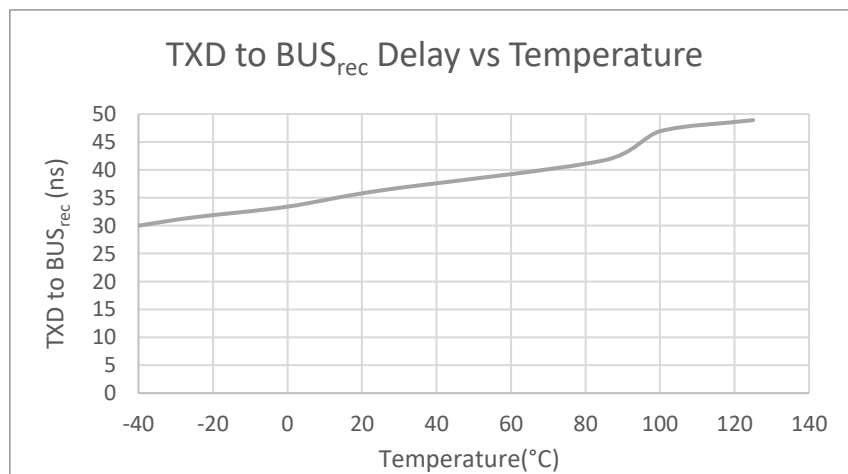
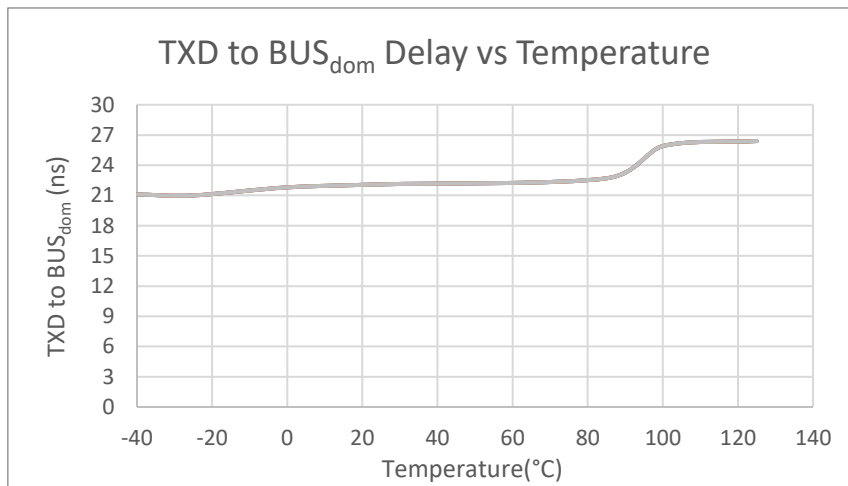


Normal Mode I_{VIO} vs Temperature (V_{CC}=5V)

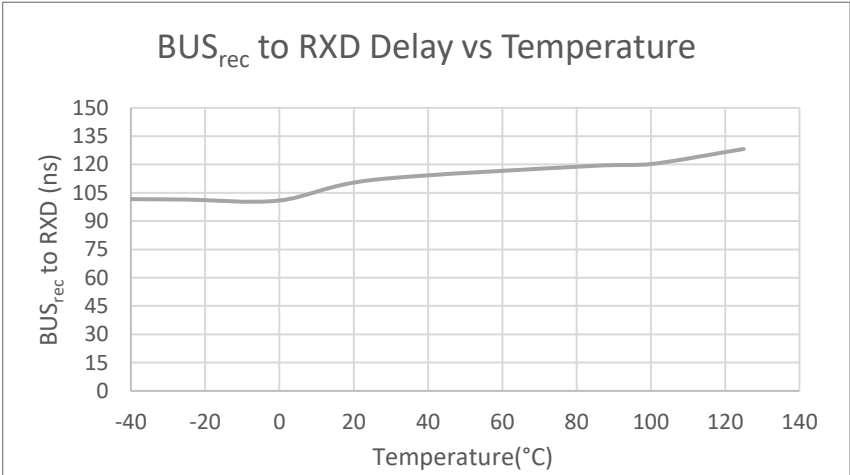
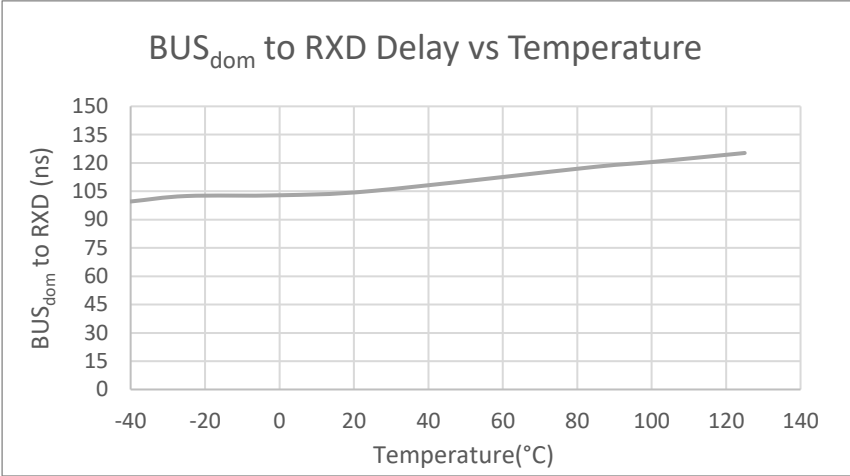
9.3 V_{OD} vs Temperature & V_{CC}



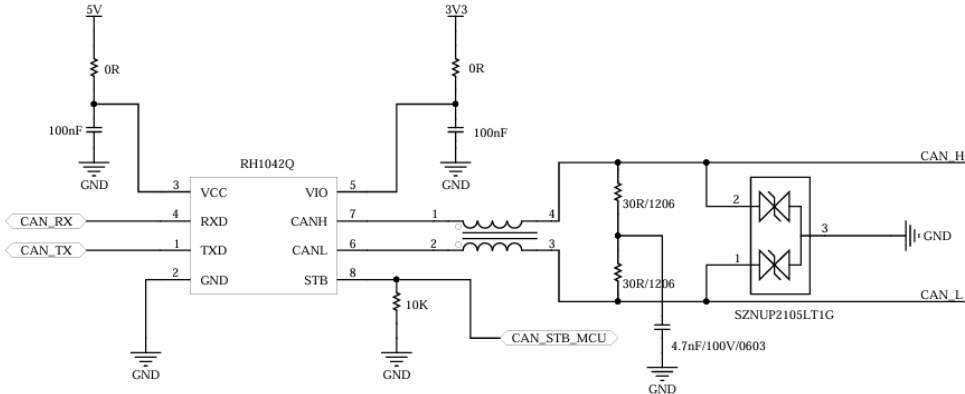
9.4 TXD to BUS Delay vs Temperature



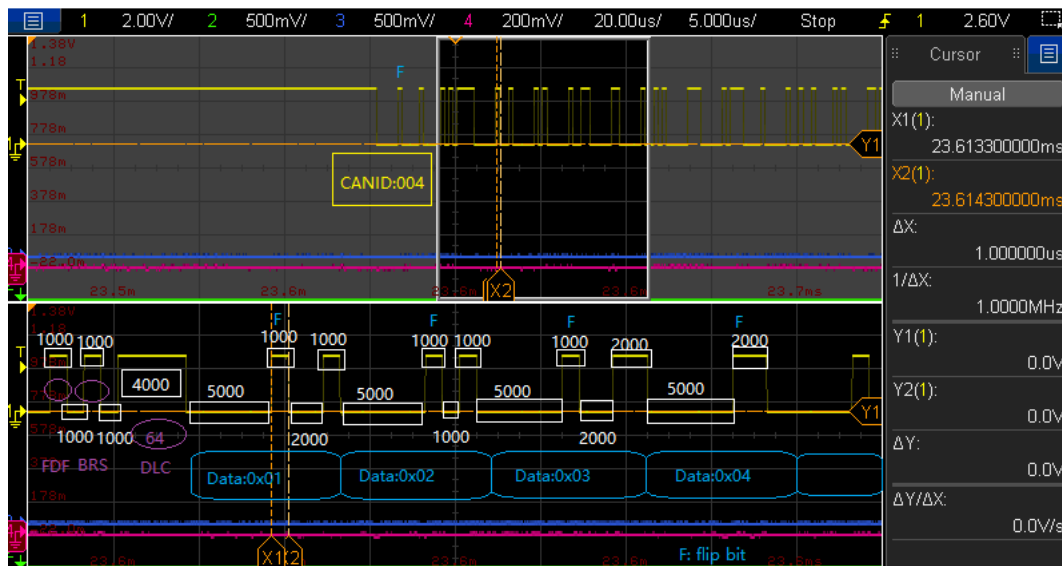
9.5 BUS to RXD Delay vs Temperature



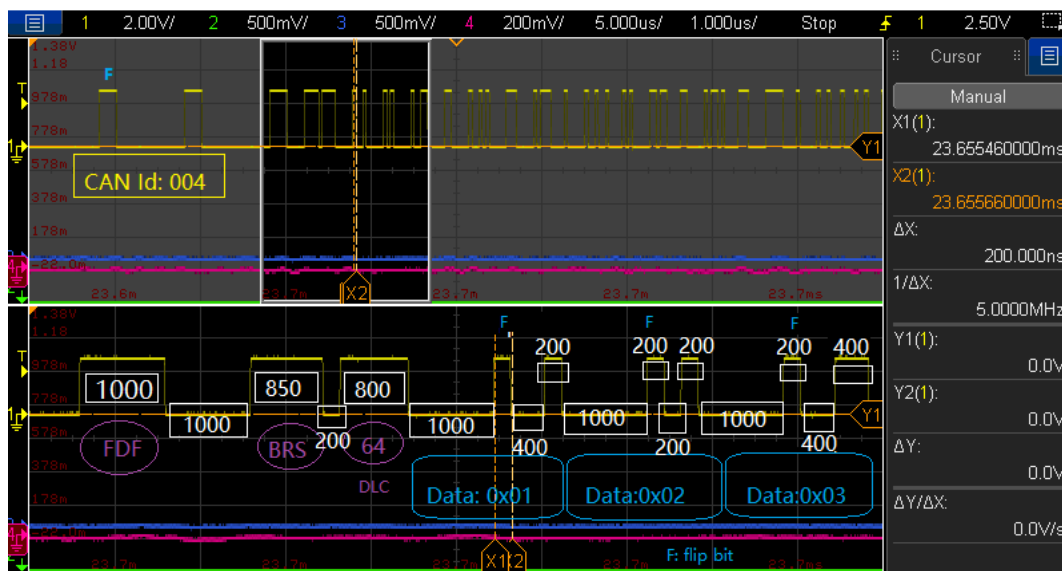
9.6 Typical Application Test Circuit



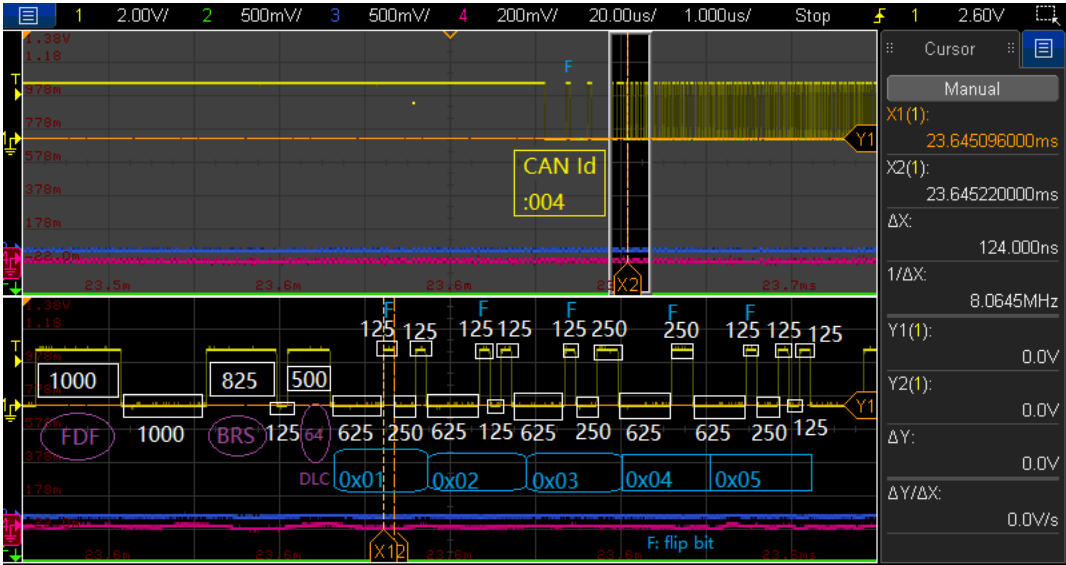
9.7 CAN FD Data Transmissions



1Mbps Data Phase and 1Mbps Arbitration Phase



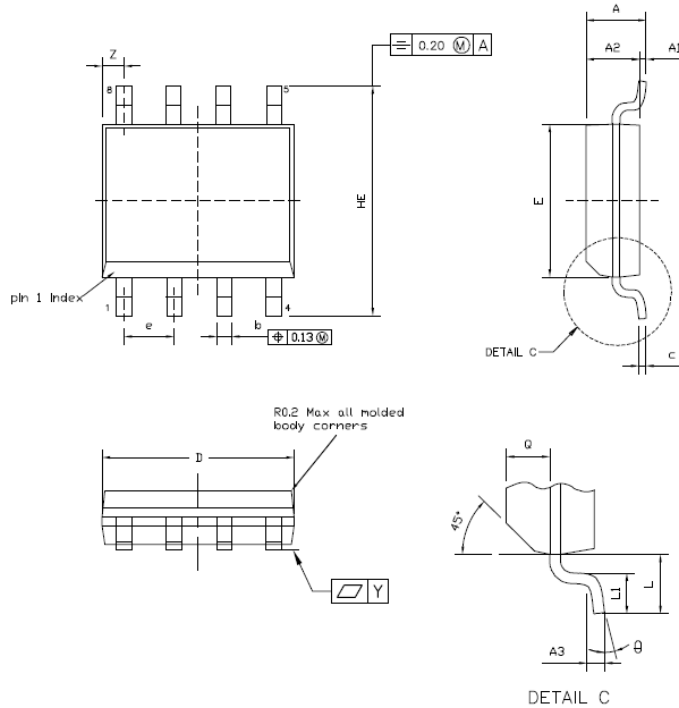
5Mbps Data Phase and 1Mbps Arbitration Phase



8Mbps Data Phase and 1Mbps Arbitration Phase

10 Package Information

Package Outline SO-8 (150 mil)



* CONTROLLING DIMENSION : MM

| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | --- | --- | 1.75 |
| A1 | 0.10 | --- | 0.25 |
| A2 | 1.25 | 1.35 | 1.45 |
| b | 0.33 | 0.38 | 0.49 |
| c | 0.19 | 0.20 | 0.25 |
| D | 4.80 | 4.90 | 5.00 |
| E | 3.80 | 3.90 | 4.00 |
| Q | 0.60 | 0.65 | 0.70 |
| HE | 5.80 | 6.00 | 6.20 |
| e | 1.27 BSC | | |
| L | 1.05 BSC | | |
| L1 | 0.40 | 0.64 | 1.00 |
| Y | --- | 0.10 | --- |
| Z | 0.3 | 0.5 | 0.7 |
| A3 | 0.25 BSC | | |
| θ | 0° | 5° | 8° |

Important Notice

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